



Serial No. 09/366,935

Docket No: YAMAP0398USB

AMENDMENT

In the Specification:

Please amend the specification, by inserting at page 1, prior to "Background of the Invention", the following reference to the parent applications:

B
This is a division of application Serial No. 08/861,943, filed May 22, 1997, now U.S. Patent No. 5,972,250, which is a division of application Serial No. 08/599,181, filed February 9, 1996, now U.S. Patent No. 5,681,634.

In the Claims:

Please amend claim 50 so as to read as follows:

B2
50. (Amended) An apparatus for fabricating an optical information medium by bonding together a first substrate having a center hole and a second substrate having a center hole with a radiation curable resin interposed therebetween, comprising:

a table for integrally rotating the first and second substrates, with the radiation curable resin interposed therebetween, before the radiation curable resin is cured; and

centrally disposed means for absorbing through the center holes of the first and second substrates the radiation curable resin interposed between the first and second substrates.

A version of the above amended claim marked to indicate the specific amendments may be found in the attached Appendix, in accordance with 37 CFR 1.121(c)(1).

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Please add the following new claims 57-64:

2 57. (New) An apparatus according to claim 50, wherein an outer diameter of the table is less than an outer diameter of each of the first and second substrates.

3 58. (New) An apparatus according to claim 57, wherein the outer diameter of the table is about 70% or more than the outer diameter of each of the first and second substrates.

4 59. (New) An apparatus according to claim 50, wherein the means for absorbing the radiation curable resin is at least one suction port.

5 60. (New) An apparatus according to claim 50, wherein the means for absorbing the radiation curable resin is a plurality of suction ports.

6 61. (New) An apparatus according to claim 50, wherein the means for absorbing the radiation curable resin comprises a suction pump.

7 62. (New) An apparatus according to claim 50, wherein the means for absorbing the radiation curable resin comprises at least one suction port in a boss.

8 63. (New) An apparatus according to claim 50, wherein the means for absorbing the radiation curable resin is a sponge.